2SAR523M / 2SAR523EB / 2SAR523UB

PNP -100mA -50V General Purpose Transistor

Datasheet

Parameter	Value
V_{CEO}	-50V
I _C	-100mA

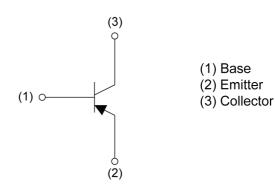
Outline

SOT-723	SOT-416FL
(1) (2)	(1) (2)
2SAR523M	2SAR523EB
(VMT3)	(EMT3F)
SOT-323FL	
(1)	
2SAR523UB	
(UMT3F)	

Features

- 1) General Purpose.
- 2) Complementary NPN Types: 2SCR523M (VMT3) / 2SCR523EB (EMT3F) / 2SCR523UB (UMT3F)

•Inner circuit



Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SAR523M	SOT-723 (VMT3)	1212	T2L	180	8	8000	PB
2SAR523EB	SOT-416FL (EMT3F)	1616	TL	180	8	3000	РВ
2SAR523UB	SOT-323FL (UMT3F)	2021	TL	180	8	3000	РВ

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● Absolute maximum ratings (T_a = 25°C)

Parameter			Values	Unit
Collector-base voltage		V_{CBO}	-50	V
Collector-emitter voltage		V _{CEO}	-50	V
Emitter-base voltage			-5	V
Calla stan average	I _C	-100	mA	
Collector current		I _{CP} *1	-200	mA
	2SAR523M		150	
Power dissipation	2SAR523EB	P _D *2	150	mW
		200		
Junction temperature	T _j	150	°C	
Range of storage tempera	T _{stg}	-55 to +150	°C	

● Electrical characteristics (T_a = 25°C)

Donomoston	Curah al	Conditions		Values		Linit	
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	I _C = -50μA	-50	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-50	-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = -50μA	-5	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = -50V	1	-	-100	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = -5V	1	-	-100	nA	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$	1	-150	-400	mV	
DC current gain	h _{FE}	V_{CE} = -6V, I_{C} = -1mA	120	-	560	-	
Transition frequency	f _T	V _{CE} = -10V, I _E = 10mA, f = 100MHz	-	300	-	MHz	
Output capacitance	C _{ob}	V _{CB} = -10V, I _E = 0A, f = 1MHz	-	2.0	-	pF	

^{*1} Pw=10ms Single Pulse

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation

Characteristics

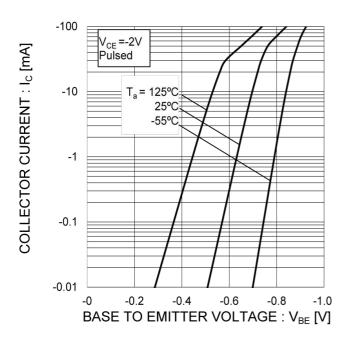
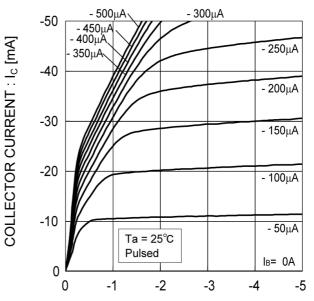


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC Current Gain vs. Collector Current (I)

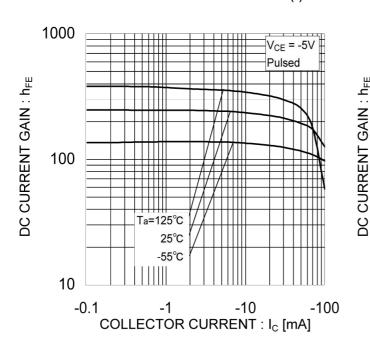
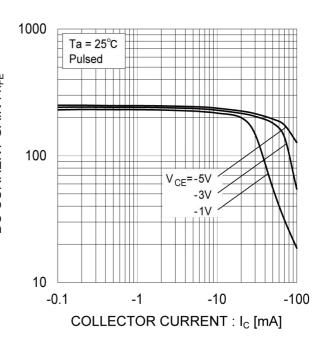


Fig.4 DC Current Gain vs. Collector Current (II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

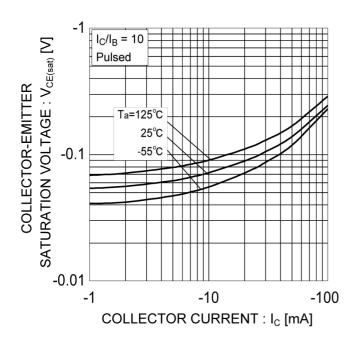


Fig.6 Collector-Emitter Saturation

Voltage vs. Collector Current (II)

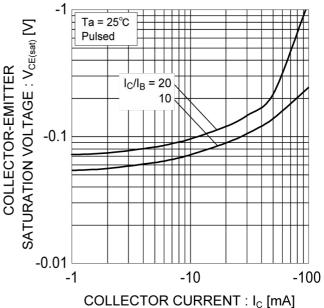


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

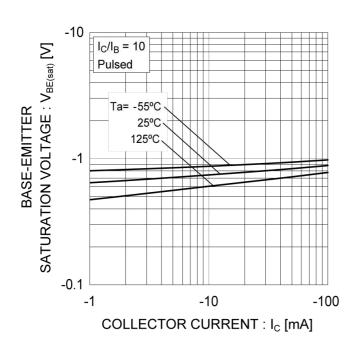
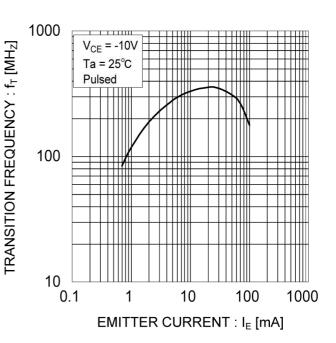


Fig.8 Gain Bandwidth Product vs.

Emitter Current



● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

COLLECTOR OUTPUT CAPACITANCE : C_{ob} [pF] 100 EMITTER INPUT CAPACITANCE : Cio [pF] Cib 10 Cob | Ta=25°C f=1MHz IE=0A Ic=0A 0.1 -0.01 -0.1 -1 -10 -100 COLLECTOR-BASE VOLTAGE: VCB [V] EMITTER-BASE VOLTAGE: VCB [V]

Fig.10 Safe Operating Area

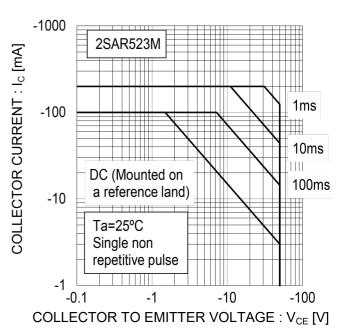


Fig.11 Safe Operating Area

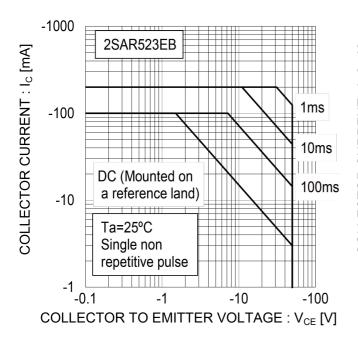
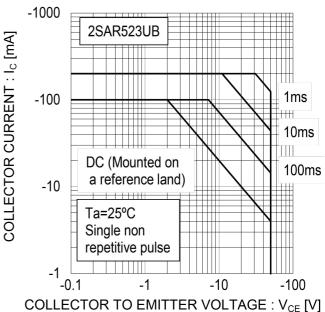
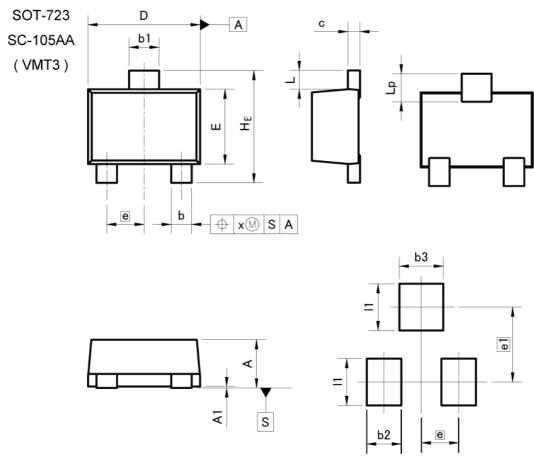


Fig.12 Safe Operating Area



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

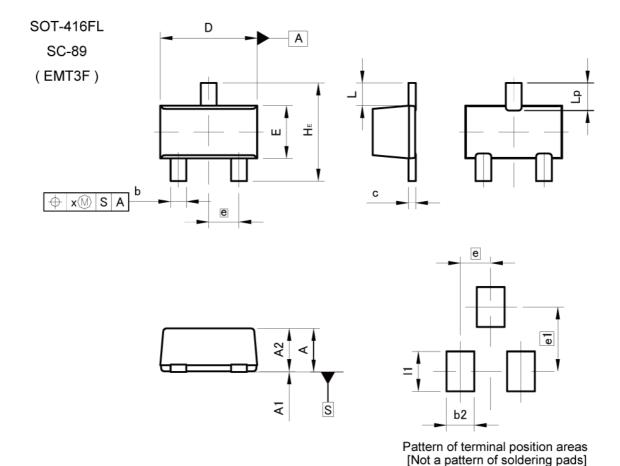
DIM	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	#	0.10	<u> </u>	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u> </u>	0.37	544	0.015
b3	223	0.47	822	0.019
e1	0.80		0.0	031
11	-	0.50	100	0.020

Dimension in mm/inches



Dimensions



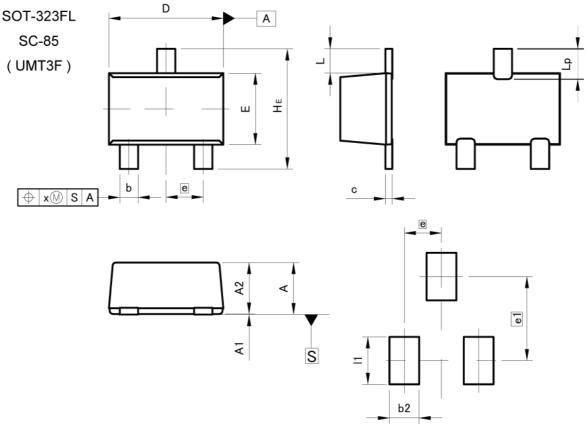
MILIMETERS INCHES DIM MIN MAX MIN MAX 0.85 0.033 A 0.65 0.026 A1 0.00 0.10 0.000 0.004 0.60 0.80 0.024 0.031 A2 b 0.21 0.36 0.008 0.014 0.007 0.08 0.18 0.003 C D 1.50 1.70 0.059 0.067 0.76 0.96 0.030 E 0.038 0.50 0.020 е HE 1.50 1.70 0.059 0.067 0.37 0.015 L 0.35 0.55 0.014 0.022 Lp 0.10 0.004 X

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	= 1	0.46	_	0.018
e1	4 :	1.05	-	0.041
11	=	0.65	=	0.026

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.026	26
HE	2.00	2.20	0.079	0.087
L	0.425		0.0	17
Lp	0.43	0.63	0.017	0.025
х	==:	0.10	-	0.004

DIM	MILIME	MILIMETERS I		HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.52	-	0.020
e1	1.47		0.0	58
I1		0.83		0.033

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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